These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

These assemblies are ESD sensitive, ESD precautions shall be observed.

Install label in silkscreen box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

Components marked 'ONP' should not be populated.

[No Variations]

M5 Assembly Top

BOARD #: TIDA-00707

TID #: TIDA-00707

GENERATED: 3-17-2016 1:46:10 PM

TEXAS INSTRUMENTS
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